



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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10A, 50V - 1000V Glass Passivated Single-Phase Bridge Rectifier

FEATURES

- Ideal for printed circuit board
- High case dielectric strength of 1500 V_{RMS}
- High surge current capability
- Typical I_R less than 0.1μA
- UL Recognized File # E-326243
- Compliant to RoHS Directive 2011/65/EU and in accordance to WEEE 2002/96/EC
- Halogen-free according to IEC 61249-2-21

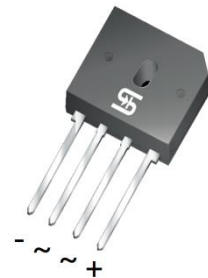
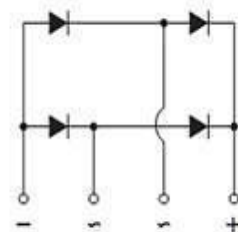
APPLICATIONS

- Switching mode power supply (SMPS)
- Adapters
- TV
- Monitor

MECHANICAL DATA

- Case: GBU
- Molding compound meets UL 94V-0 flammability rating
- Packing code with suffix "G" means green compound (halogen-free)
- Part no. with suffix "H" means AEC-Q101 qualified
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Polarity: As marked
- Weight: 4 g (approximately)

KEY PARAMETERS		
PARAMETER	VALUE	UNIT
I _{F(AV)}	10	A
V _{RRM}	50 – 1000	V
I _{FSM}	220	A
T _{J MAX}	150	°C
Package	GBU	
Configuration	Quad	


GBU


ABSOLUTE MAXIMUM RATINGS (T_A = 25°C unless otherwise noted)

PARAMETER	SYMBOL	GBU 1001	GBU 1002	GBU 1003	GBU 1004	GBU 1005	GBU 1006	GBU 1007	UNIT
Marking code on the device		GBU 1001	GBU 1002	GBU 1003	GBU 1004	GBU 1005	GBU 1006	GBU 1007	
Repetitive peak reverse voltage	V _{RRM}	50	100	200	400	600	800	1000	V
Reverse voltage, total rms value	V _{R(RMS)}	35	70	140	280	420	560	700	V
Maximum DC blocking voltage	V _{DC}	50	100	200	400	600	800	1000	V
Forward current	I _{F(AV)}	10							A
Surge peak forward current, 8.3 ms single half sine-wave superimposed on rated load per diode)	I _{FSM}	220							A
Rating of fusing (t<8.3ms)	I ² t	200							A ² s
Junction temperature	T _J	- 55 to +150							°C
Storage temperature	T _{STG}	- 55 to +150							°C

THERMAL PERFORMANCE			
PARAMETER	SYMBOL	LIMIT	UNIT
Junction-to-ambient thermal resistance	$R_{\theta JA}$	21	°C/W
Junction-to-case thermal resistance	$R_{\theta JC}$	2	°C/W

ELECTRICAL SPECIFICATIONS ($T_A = 25^\circ\text{C}$ unless otherwise noted)						
PARAMETER		CONDITIONS	SYMBOL	TYP	MAX	UNIT
Forward voltage per diode ⁽¹⁾		$I_F = 5\text{A}, T_J = 25^\circ\text{C}$	V_F	-	1.0	V
		$I_F = 10\text{A}, T_J = 25^\circ\text{C}$		-	1.1	V
Reverse current @ rated V_R per diode ⁽²⁾		$T_J = 25^\circ\text{C}$	I_R	-	5	μA
		$T_J = 125^\circ\text{C}$		-	500	μA
Junction capacitance	GBU1001 GBU1002 GBU1003 GBU1004	1 MHz, $V_R = 4.0\text{V}$	C_J	211	-	pF
	GBU1005 GBU1006 GBU1007			94	-	pF

Notes:

1. Pulse test with $PW = 0.3\text{ ms}$
2. Pulse test with $PW = 30\text{ ms}$

ORDERING INFORMATION					
PART NO.	PART NO. SUFFIX	PACKING CODE	PACKING CODE SUFFIX(*)	PACKAGE	PACKING
GBU100x (Note 1)	H	C2	G	GBU	20 / Tube
		D2			20 / Tube
		X0			Forming

Note:

1. "x" defines voltage from 50V (GBU1001) to 1000V (GBU1007)
- *: Optional available

EXAMPLE P/N					
EXAMPLE P/N	PART NO.	PART NO. SUFFIX	PACKING CODE	PACKING CODE SUFFIX	DESCRIPTION
GBU1006HC2G	GBU1006	H	C2	G	AEC-Q101 qualified Green compound

CHARACTERISTICS CURVES

($T_A = 25^\circ\text{C}$ unless otherwise noted)

Fig.1 Forward Current Derating Curve

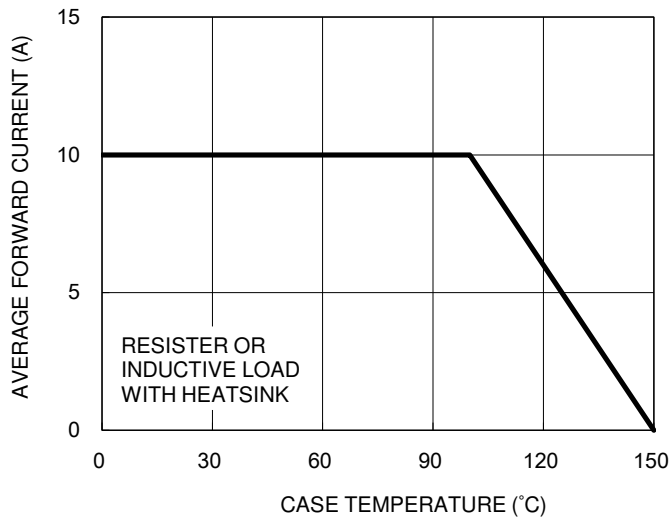


Fig.2 Typical Junction Capacitance

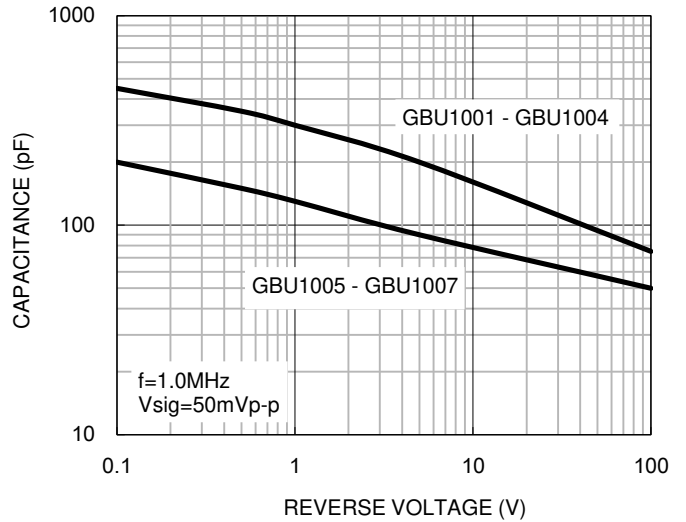


Fig.3 Typical Reverse Characteristics

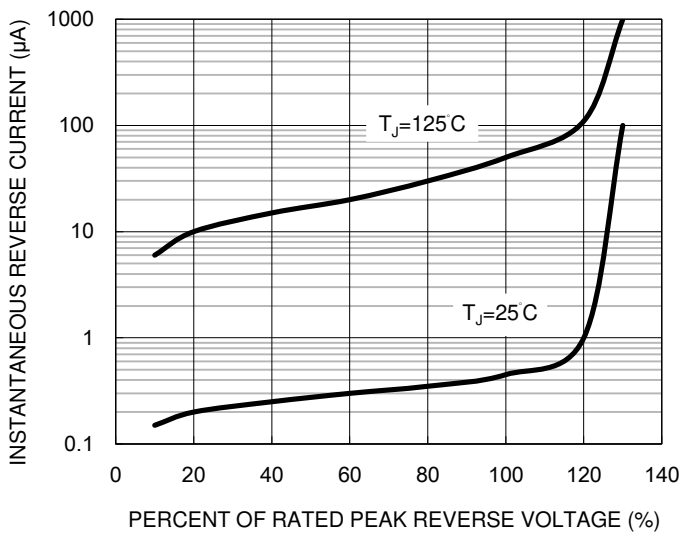
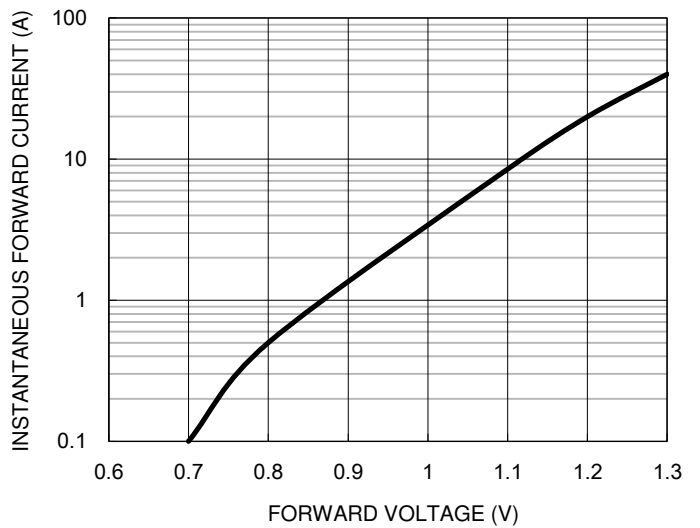


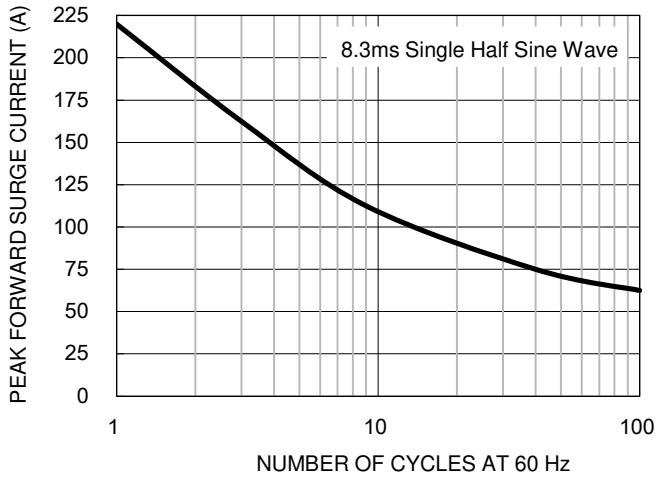
Fig.4 Typical Forward Characteristics



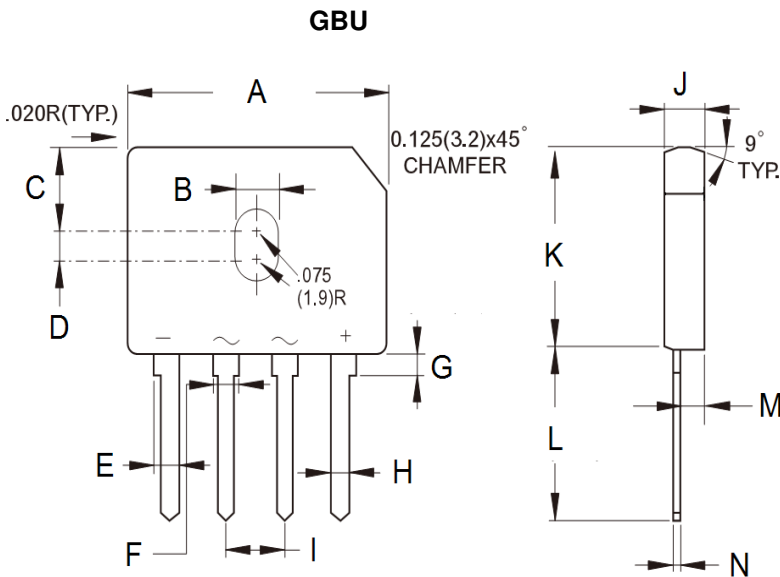
CHARACTERISTICS CURVES

($T_A = 25^\circ\text{C}$ unless otherwise noted)

Fig.5 Maximum Non-repetitive Forward Surge Current



PACKAGE OUTLINE DIMENSIONS



DIM.	Unit (mm)		Unit (inch)	
	Min	Max	Min	Max
A	21.80	22.30	0.858	0.878
B	3.50	4.10	0.138	0.161
C	7.40	7.90	0.291	0.311
D	1.65	2.16	0.065	0.085
E	2.16	2.54	0.085	0.100
F	1.65	2.03	0.065	0.080
G	1.52	2.03	0.060	0.080
H	1.02	1.27	0.040	0.050
I	4.83	5.33	0.190	0.210
J	3.30	3.56	0.130	0.140
K	18.30	18.80	0.720	0.740
L	17.50	18.00	0.689	0.709
M	1.90	2.16	0.075	0.085
N	0.46	0.56	0.018	0.022

MARKING DIAGRAM



- P/N = Marking Code
- G = Green Compound
- YWW = Date Code
- F = Factory Code

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